

# 600V, 20A, Trench FS II Fast IGBT

## General Description:

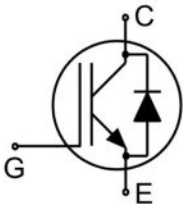
Using MJ's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

## Features

- ◆ Trench FSII Technology offering
- ◆ Very low  $V_{CE(sat)}$
- ◆ High speed switching
- ◆ Positive temperature coefficient in  $V_{CE(sat)}$
- ◆ Very tight parameter distribution
- ◆ High ruggedness, temperature stable behavior

## Application

- ◆ Air Condition
- ◆ Inverters
- ◆ Motor drives



Schematic diagram



TO-263

## Package Marking and Ordering Information

| Device     | Device Package | Device Marking |
|------------|----------------|----------------|
| MJ20TD60BD | TO-263         | MJ20TD60BD     |

## Absolute Maximum Ratings ( $T_c=25^{\circ}\text{C}$ unless otherwise noted)

| Parameter  | Symbol         | Value       | Units              |
|--|----------------|-------------|--------------------|
| Collector-Emitter Voltage  | $V_{CES}$      | 600         | V                  |
| Gate- Emitter Voltage  | $V_{GES}$      | $\pm 30$    | V                  |
| Collector Current  | $I_C$          | 40          | A                  |
| Collector Current @ $T_c = 100^{\circ}\text{C}$  | $I_C$          | 20          | A                  |
| Pulsed Collector Current, $t_p$ limited by $T_{jmax}$  | $I_{Cplus}$    | 60          | A                  |
| turn off safe operating area, $V_{CE}=600\text{V}$ , $T_j=150^{\circ}\text{C}$   | -              | 60          | A                  |
| Diode Continuous Forward Current @ $T_c = 100^{\circ}\text{C}$   | $I_F$          | 20          | A                  |
| Diode Maximum Forward Current  | $I_{FM}$       | 60          | A                  |
| Power Dissipation @ $T_c = 25^{\circ}\text{C}$   | $P_D$          | 163         | W                  |
| Power Dissipation @ $T_c = 100^{\circ}\text{C}$  | $P_D$          | 81.5        | W                  |
| Operating Junction and Storage Temperature Range   | $T_J, T_{stg}$ | -55 to +175 | $^{\circ}\text{C}$ |
| Maximum Temperature for Soldering  | $T_L$          | 260         | $^{\circ}\text{C}$ |
| Short circuit withstand time $V_{GE}=15.0\text{V}$ , $V_{CC}\leq 400\text{V}$ , Allowed number of short circuits<1000Time between short circuits: $\geq 1.0\text{s}$ , $T_j\leq 150^{\circ}\text{C}$ | $t_{sc}$       | 5           | us                 |

Thermal Characteristic

| Parameter                                      | Symbol          | Value | Units                |
|--|-----------------|-------|----------------------|
| Thermal Resistance, Junction to case for IGBT  | $R_{\theta JC}$ | 0.92  | $^{\circ}\text{C/W}$ |
| Thermal Resistance, Junction to case for Diode | $R_{\theta JC}$ | 1.92  | $^{\circ}\text{C/W}$ |
| Thermal Resistance, Junction to Ambient        | $R_{\theta JA}$ | 62    | $^{\circ}\text{C/W}$ |

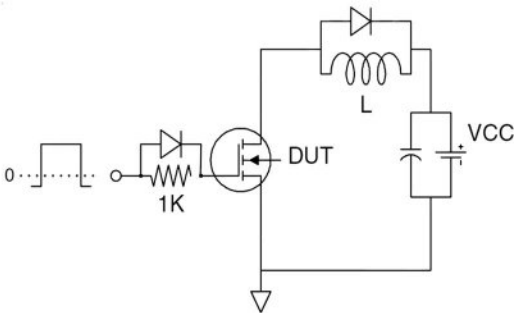
Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)

| Parameter   | Symbol               | Test Conditions  |                       | Value |      |     | Units |
|---|----------------------|--|-----------------------|-------|------|-----|-------|
|   |                      |  |                       | Min   | Typ  | Max |       |
| Static Characteristics  |                      |  |                       |       |      |     |       |
| Collector-Emitter Breakdown Voltage   | V <sub>(BR)CES</sub> | V <sub>GE</sub> =0V,I <sub>CE</sub> =1mA   |                       | 600   | -    | -   | V     |
| Collector-Emitter Leakage Current   | I <sub>CES</sub>     | V <sub>GE</sub> =0V,V <sub>CE</sub> =600V  |                       | -     | -    | 4   | uA    |
| Gate to Emitter Forward Leakage   | I <sub>GES(F)</sub>  | V <sub>GE</sub> =+30V,V <sub>CE</sub> =0V  |                       | -     | -    | 100 | nA    |
| Gate to Source Reverse Leakage  | I <sub>GES(R)</sub>  | V <sub>GE</sub> =-30V,V <sub>CE</sub> =0V  |                       | -     | -    | 100 | nA    |
| Collector-Emitter Saturation Voltage  | V <sub>CE(sat)</sub> | I <sub>C</sub> =20A<br>V <sub>GE</sub> =15V  | T <sub>J</sub> =25°C  | -     | 1.7  | 1.9 | V     |
|   |                      |  | T <sub>J</sub> =100°C | -     | 1.9  | -   | V     |
| Gate Threshold Voltage  | V <sub>GE(th)</sub>  | I <sub>C</sub> =1mA, V <sub>CE</sub> =V <sub>GE</sub>  |                       | 4.0   | -    | 6.0 | V     |
| Dynamic Characteristics   |                      |  |                       |       |      |     |       |
| Input Capacitance   | C <sub>ies</sub>     | V <sub>CE</sub> =25V,V <sub>GE</sub> =0V,<br>f=1MHz  |                       | -     | 2580 | -   | pF    |
| Output Capacitance  | C <sub>Oss</sub>     |  |                       | -     | 48   | -   | pF    |
| Reverse Transfer Capacitance  | C <sub>rss</sub>     |  |                       | -     | 26   | -   | pF    |
| Total Gate Charge   | Q <sub>g</sub>       | V <sub>CC</sub> =480V, I <sub>C</sub> =20A<br>V <sub>GE</sub> =15V   |                       | -     | 97   | -   | nC    |
| Gate to Emitter Charge  | Q <sub>ge</sub>      |  |                       | -     | 17   | -   | nC    |
| Gate to Collector Charge  | Q <sub>gc</sub>      |  |                       | -     | 37   | -   | nC    |
| Short circuit collector current Max.1000 short circuits<br>Time between short circuits: ≥1.0s | I <sub>C(SC)</sub>   | V <sub>GE</sub> =15V,V <sub>CC</sub> ≤400V,<br>t <sub>sc</sub> ≤5us,T <sub>J</sub> ≤150°C                  |                       | -     | 130  | -   | A     |
| Switching Characteristics   |                      |  |                       |       |      |     |       |
| Turn-on Delay Time  | t <sub>d(ON)</sub>   | V <sub>CC</sub> =400V,I <sub>C</sub> =10A<br>V <sub>GE</sub> =0/15V, R <sub>g</sub> =25Ω<br>Inductive Load |                       | -     | 18   | -   | ns    |
| Rise Time   | t <sub>r</sub>       |  |                       | -     | 16   | -   | ns    |
| Turn-Off Delay Time   | t <sub>d(OFF)</sub>  |  |                       | -     | 164  | -   | ns    |
| Fall Time   | t <sub>f</sub>       |  |                       | -     | 15   | -   | ns    |
| Turn-On Switching Loss  | E <sub>on</sub>      |  |                       | -     | 0.43 | -   | mJ    |
| Turn-Off Switching Loss   | E <sub>off</sub>     |  |                       | -     | 0.17 | -   | mJ    |
| Total Switching Loss  | E <sub>ts</sub>      |  |                       | -     | 0.60 | -   | mJ    |

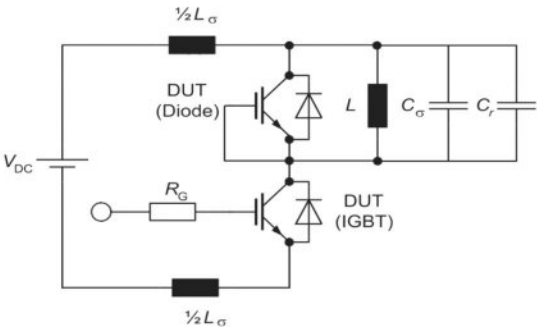
# Electrical Characteristics of the Diode (Tc= 25°C unless otherwise specified):

| Parameter                           | Symbol           | Test Conditions                    | Rating |      |     | Units |
|-------------------------------------|------------------|------------------------------------|--------|------|-----|-------|
|                                     |                  |                                    | Min    | Typ  | Max |       |
| Diode Forward Voltage               | V <sub>FM</sub>  | I <sub>F</sub> =20A                | -      | 1.45 | 1.7 | V     |
| Reverse Recovery Time               | T <sub>rr</sub>  | I <sub>F</sub> =20A, di/dt=200A/uS | -      | 182  | -   | ns    |
| Diode Peak Reverse Recovery Current | I <sub>RRM</sub> |                                    | -      | 5.3  | -   | A     |
| Reverse Recovery Charge             | Q <sub>rr</sub>  |                                    | -      | 0.5  | -   | uC    |
| Pulse width ttp≤380μs,δ≤2%          |                  |                                    |        |      |     |       |

## Test Circuit

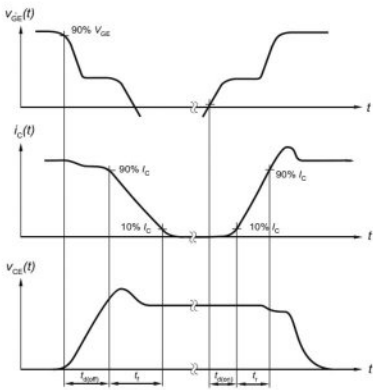


Gate Charge Test Circuit

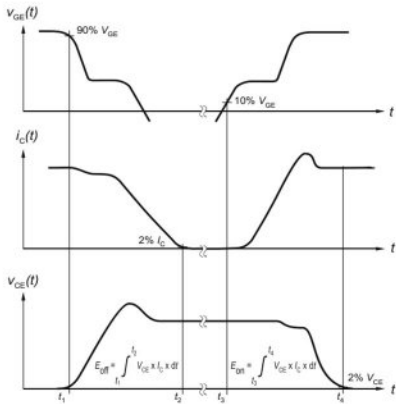


Switch Time Test Circuit

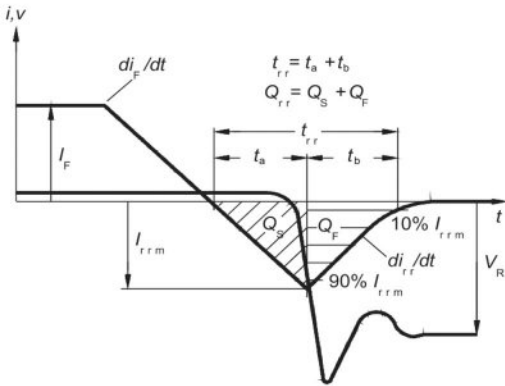
## Switching characteristics



definition of switching times

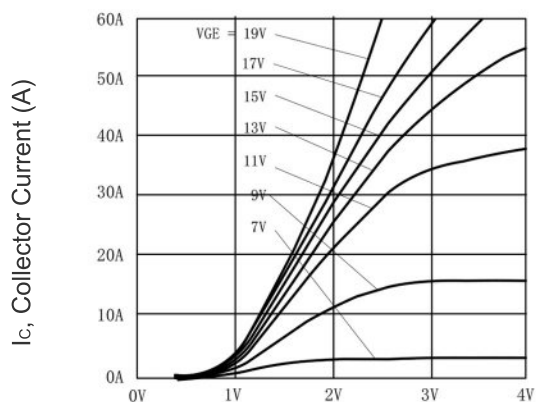


definition of switching losses



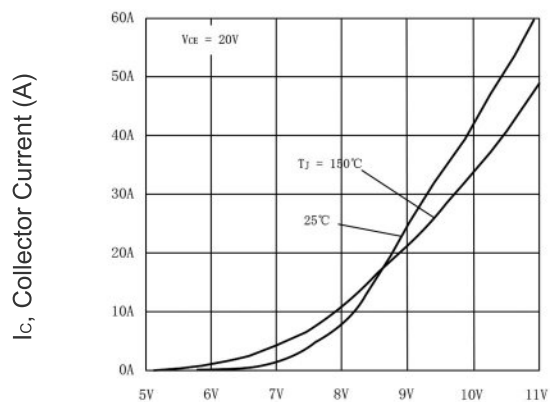
Definition of diode switching characteristics

## Typical Electrical and Thermal Characteristics



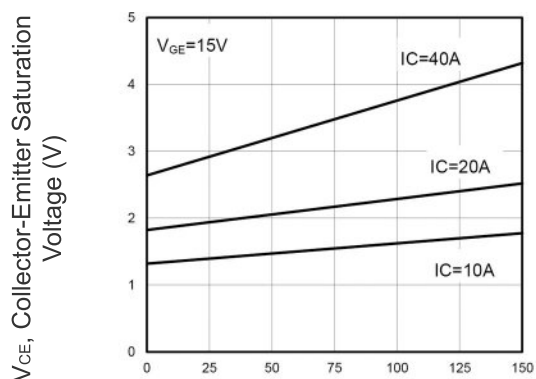
$V_{CE}$ , Collector-Emitter Voltage (V)

Figure 1 Output Characteristics



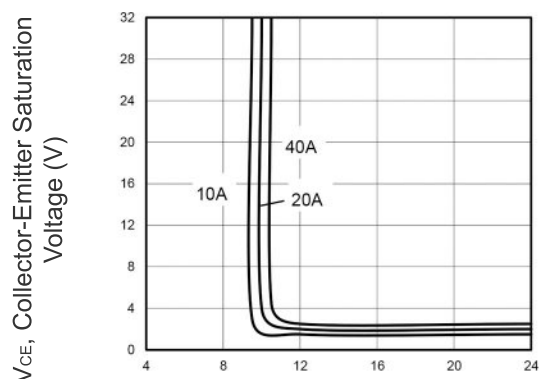
$V_{GE}$ , Gate-Emitter Voltage (V)

Figure 2 Transfer Characteristics



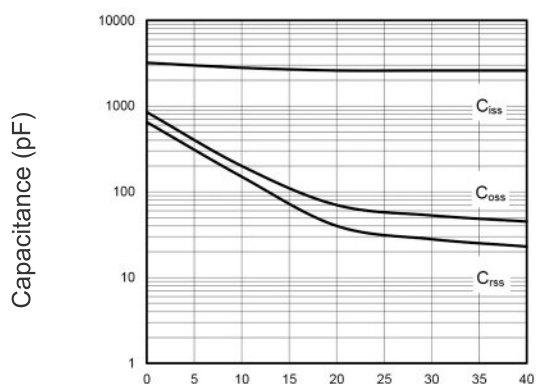
$T_J$ , Junction Temperature ( $^{\circ}\text{C}$ )

Figure 3  $V_{CEsat}$  vs. Case Temperature



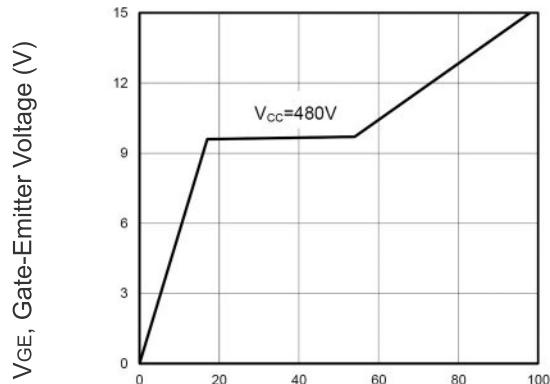
$V_{GE}$ , Gate-Emitter Voltage (V)

Figure 4 Saturation Voltage vs.  $V_{GE}$



$V_{CE}$ , Collector-Emitter Voltage (V)

Figure 5 Capacitance Characteristics



$Q_G$ , Total Gate Charge (nC)

Figure 6 Gate charge waveform

Typical Electrical and Thermal Characteristics (continued)

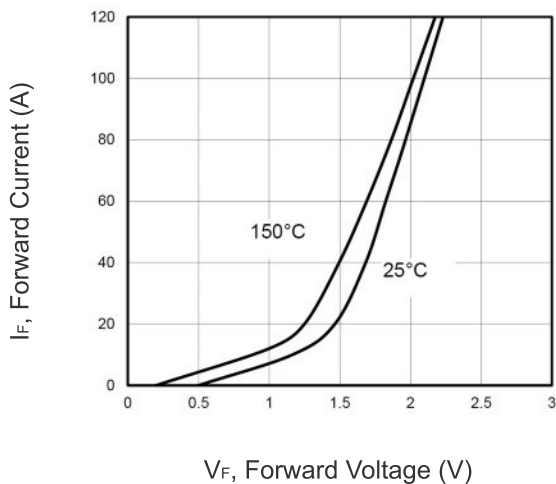


Figure 7 Forward Characteristics

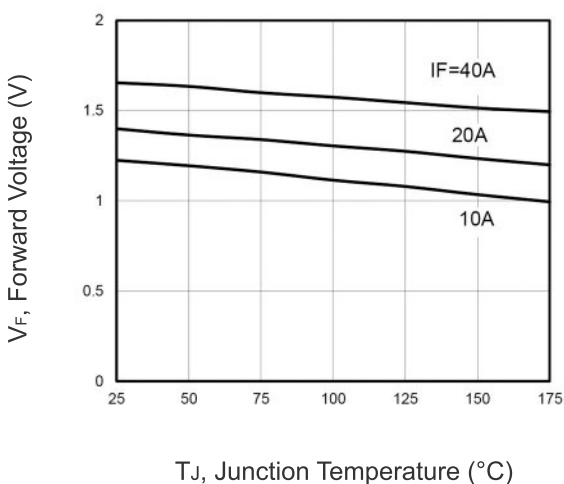


Figure 8 VF vs. Temperature

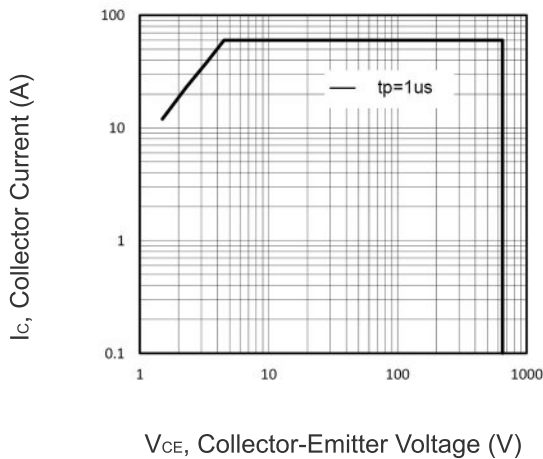


Figure 9 Forward Bias Safe Operating

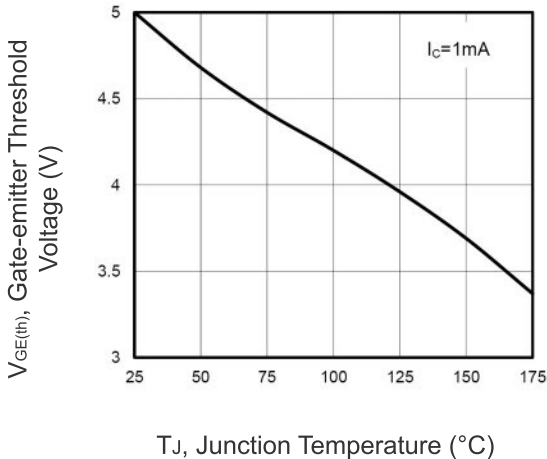


Figure 10 Gate-emitter Threshold Voltage as a Function of Junction Temperature

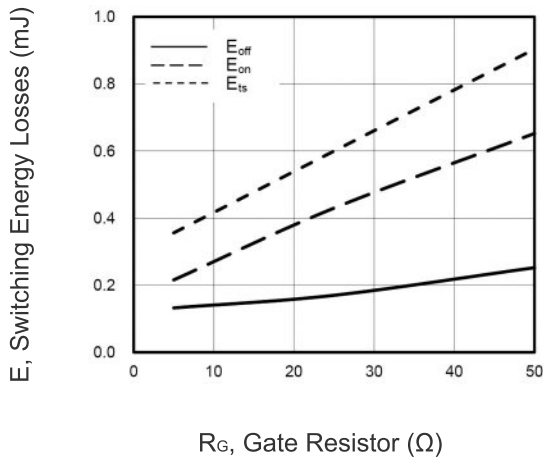


Figure 11 Typical Switching Times as a Function of Gate Resistor

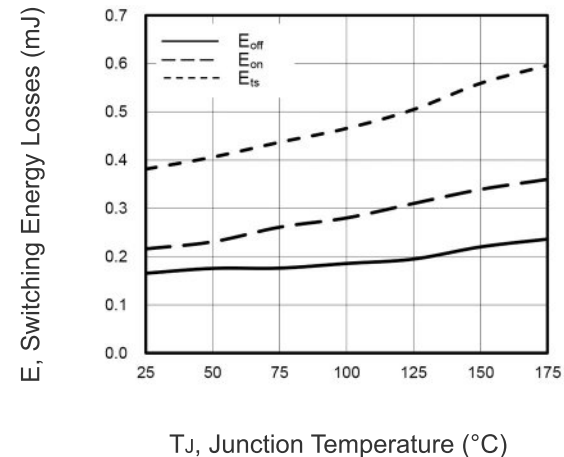


Figure 12 Typical Switching Times as a Function of Junction Temperature

## Typical Electrical and Thermal Characteristics (continued)

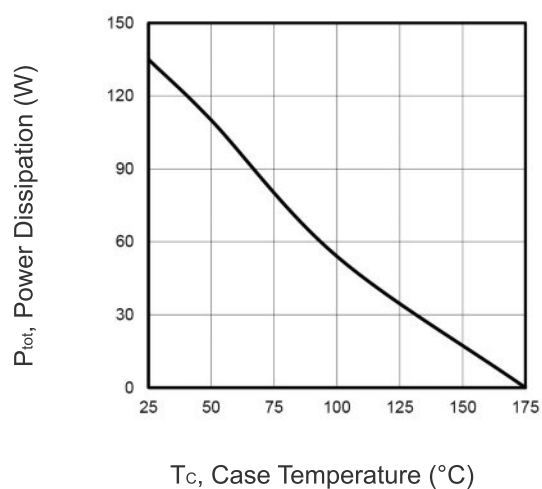
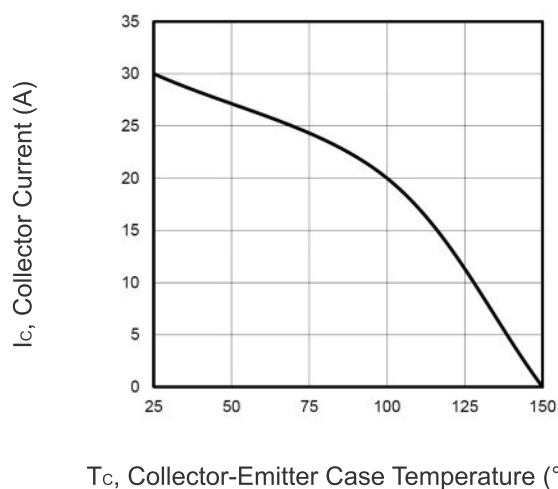
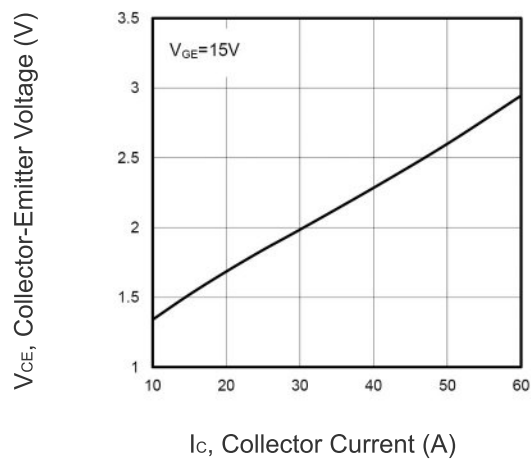


Figure 13 Power Dissipation as a Function of Case Temperature



T<sub>c</sub>, Collector-Emitter Case Temperature (°C)

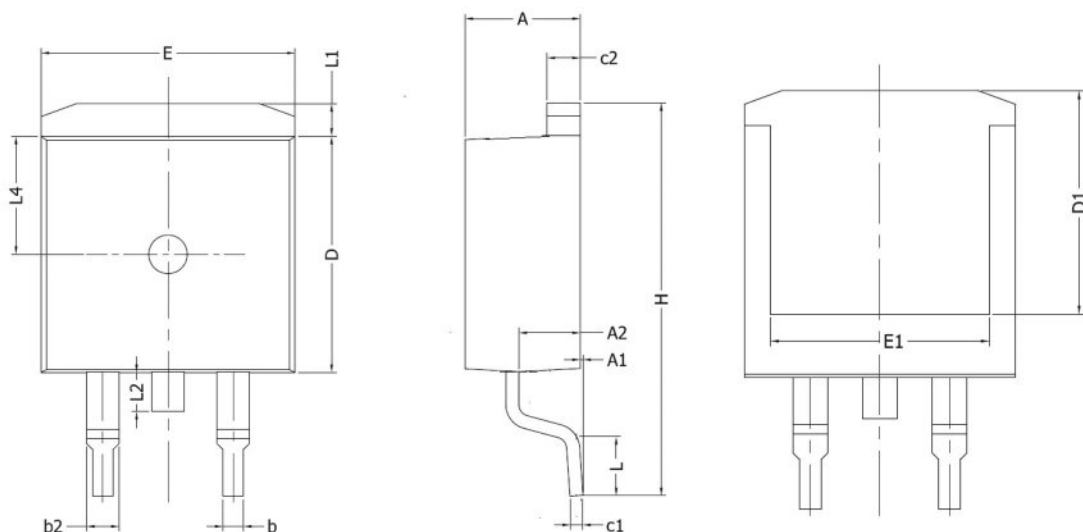
Figure 14 Current Derating



I<sub>c</sub>, Collector Current (A)

Figure 15 Typical Collector-emitter Saturation Voltage as a function of Collector Current

# TO-263-3L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |      |
|--------|---------------------------|-------|----------------------|------|
|        | Min.                      | Max.  | Min.                 | Max. |
| A      | 4.40                      | 4.60  | 0.17                 | 0.18 |
| A1     | 0.00                      | 0.25  | 0.00                 | 0.01 |
| A2     | 2.20                      | 2.60  | 0.09                 | 0.10 |
| b      | 0.76                      | 0.89  | 0.03                 | 0.04 |
| b2     | 1.23                      | 1.37  | 0.04                 | 0.05 |
| C      | 0.47                      | 0.60  | 0.01                 | 0.02 |
| c1     | 0.46                      | 0.56  | 0.18                 | 0.02 |
| c2     | 1.25                      | 1.35  | 0.05                 | 0.05 |
| D      | 9.10                      | 9.30  | 0.35                 | 0.36 |
| D1     | 8.00                      | -     | 0.31                 | -    |
| E      | 9.80                      | 10.00 | 0.38                 | 0.39 |
| E1     | 7.80                      | -     | 0.31                 | -    |
| e      | 2.54BSC                   |       | 0.10BSC              |      |
| H      | 14.90                     | 15.70 | 0.59                 | 0.62 |
| L      | 2.00                      | 2.60  | 0.08                 | 0.10 |
| L1     | 1.17                      | 1.40  | 0.05                 | 0.06 |
| L2     | -                         | 1.75  | -                    | 0.07 |
| L4     | 4.60REF                   |       | 0.18REF              |      |

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